

LOCTITE[®] 4850™

January 2008

PRODUCT DESCRIPTION

LOCTITE[®] 4850™ provides following product the characteristics:

Technology	Cyanoacrylate		
Chemical Type	Ethyl / butyl cyanoacrylate		
Appearance (uncured)	Clear colorless liquid ^{LMS}		
Components	One part - requires no mixing		
Viscosity	Medium		
Cure	Humidity		
Application	Bonding		
Key Substrates	Leather, Fabric and Paper		

LOCTITE[®] 4850[™] is designed for the assembly of difficult to bond materials and is specifically formulated to provide flexible bondlines. The product provides rapid bonding of a wide range of materials, including metals, plastics and elastomers. When used to bond rubbers, for example, this product maintains the full compressibility of the joint. LOCTITE® 4850™ particularly suited for bonding porous or absorbent materials such as paper, leather and fabrics.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Specific Gravity @ 25 °C Flash Point - See MSDS Viscosity, Cone & Plate, mPa·s (cP):

Temperature: 25 °C, Shear Rate: 100 s-1 250 to 500^{LMS}

TYPICAL CURING PERFORMANCE

Under normal conditions, the atmospheric moisture initiates the curing process. Although full functional strength is developed in a relatively short time, curing continues for at least 24 hours before full chemical/solvent resistance is developed.

Cure Speed vs. Substrate

The rate of cure will depend on the substrate used. The table below shows the fixture time achieved on different materials at 22 °C / 50 % relative humidity. This is defined as the time to develop a shear strength of 0.1 N/mm².

Fixture Time seconds:

Fixture Time, seconds:	
Paper	≤15 ^{LMS}
Steel (grit blasted)	5 to 15
Aluminum (grit blasted)	5 to 20
Steel (degreased)	5 to 30
Aluminum (degreased)	5 to 15
Zinc dichromate	5 to 20
Rubber, nitrile	5 to 15
ABS	3 to 5
PVC	3 to 10
Polycarbonate	3 to 10
Epoxy FR4	<3
Leather	5 to 20
Wood (teak)	30 to 75

Cure Speed vs. Bond Gap

The rate of cure will depend on the bondline gap. Thin bond lines result in high cure speeds, increasing the bond gap will decrease the rate of cure.

Cure Speed vs. Activator

Where cure speed is unacceptably long due to large gaps, applying activator to the surface will improve cure speed. However, this can reduce ultimate strength of the bond and therefore testing is recommended to confirm effect.

TYPICAL PROPERTIES OF CURED MATERIAL

Cured for 24 hours @ 22 °C

Physical Properties:

Coefficient of Thermal Expansion, 100×10⁻⁶ ISO 11359-2, K⁻¹

Glass Transition Temperature, ASTM E 228, 60

Shore Hardness, ISO 868, Durometer A 80 to 90 Tensile Modulus, ISO 527-3 515 to 675 N/mm² (isq) (74,695 to 97,900)

Electrical Properties:

Volume Resistivity, IEC 60093, Ω·cm 332×10¹² Surface Resistivity, IEC 60093, Ω >1×10¹⁵ Dielectric Breakdown Strength, 25

IEC 60243-1, kV/mm

Dielectric Constant / Dissipation Factor, IEC 60250:

0.1 kHz 1.09 / < 0.05 100 kHz 1.03 / < 0.05 1,000 kHz 0.1 / < 0.05

TYPICAL PERFORMANCE OF CURED MATERIAL **Adhesive Properties**

Cured for 30 seconds @ 22 °C Tensile Strength, ISO 6922:

Buna-N N/mm² ≥7 $(\geq 1,015)$ (psi)

Cured for 7 days @ 22 °C

Lap Shear Strength, ISO 4587:

Steel (grit blasted) N/mm² 11 to 15 (psi) (1,595 to 2,175) Aluminum (grit blasted) N/mm² 10 to 14 (1,450 to 2,030) (psi) Zinc dichromate N/mm² 6 to 12 (psi) (870 to 1,740) ABS N/mm² 7 to 9 (psi) (1,015 to 1,305) **PVC** N/mm² 3 to 7 (435 to 1,015) (psi) Polycarbonate N/mm² 6 to 10 (psi) (870 to 1,450) Epoxy FR4 N/mm² 12 to 16 (1,740 to 2,320) (psi) Wood (teak) N/mm² 5 to 9 (isq) (725 to 1,305)

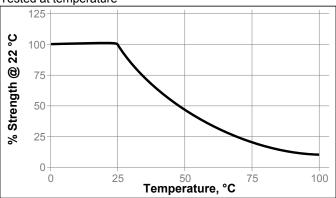


TYPICAL ENVIRONMENTAL RESISTANCE

Cured for 1 week @ 22 °C Lap Shear Strength, ISO 4587: Mild steel (grit blasted)

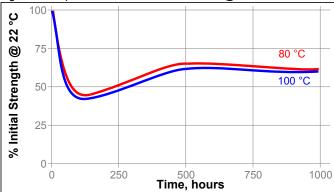
Hot Strength

Tested at temperature



Heat Aging

Aged at temperature indicated and tested @ 22 °C



Chemical/Solvent Resistance

Aged under conditions indicated and tested @ 22 °C.

		% of initial strength		
Environment	°C	100 h	500 h	1000 h
Motor oil (MIL-L-46152)	40	70	80	60
Gasoline	22	90	90	85
Ethanol	22	95	80	45
Isopropanol	22	105	105	90
Heat/humidity 95% RH	40	50	45	40
Heat/humidity 95% RH on polycarbonate	40	100	100	100

GENERAL INFORMATION

This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

Directions for use

- For best performance bond surfaces should be clean and free from grease.
- 2. This product performs best in thin bond gaps (0.05 mm).
- 3. Excess adhesive can be dissolved with Loctite cleanup solvents, nitromethane or acetone.

Loctite Material Specification^{LMS}

LMS dated August 13, 2001. Test reports for each batch are available for the indicated properties. LMS test reports include selected QC test parameters considered appropriate to specifications for customer use. Additionally, comprehensive controls are in place to assure product quality and consistency. Special customer specification requirements may be coordinated through Henkel Quality.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 2 °C to 8 °C. Storage below 2 °C or greater than 8 °C can adversely affect product properties. Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches μm / 25.4 = mil N x 0.225 = lb N/mm x 5.71 = lb/in N/mm² x 145 = psi MPa x 145 = psi N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

Note

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

Trademark usage

Except as otherwise noted, all trademarks in this document are trademarks of Henkel Corporation in the U.S. and elsewhere. [®] denotes a trademark registered in the U.S. Patent and Trademark Office.

Reference 1.2